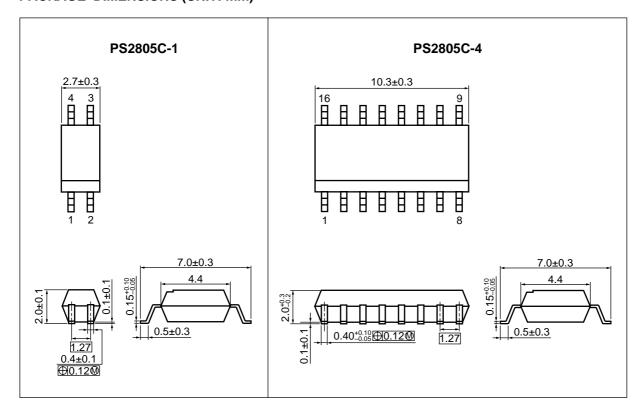
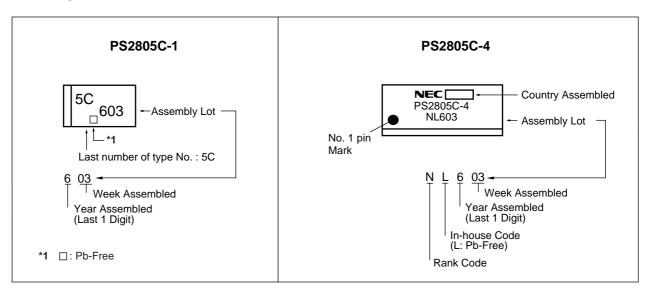
PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number*
PS2805C-1	PS2805C-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2805C-1
PS2805C-1-F3	PS2805C-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2805C-1-F4	PS2805C-1-F4-A				
PS2805C-4	PS2805C-4-A		Magazine Case 45 pcs		PS2805C-4
PS2805C-4-F3	PS2805C-4-F3-A		Embossed Tape 2 500 pcs/reel		
PS2805C-4-F4	PS2805C-4-F4-A				
PS2805C-1-V	PS2805C-1-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	PS2805C-1
PS2805C-1-V-F3	PS2805C-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2805C-1-V-F4	PS2805C-1-V-F4-A			Approved (Option)	
PS2805C-4-V	PS2805C-4-V-A		Magazine Case 45 pcs		PS2805C-4
PS2805C-4-V-F3	PS2805C-4-V-F3-A		Embossed Tape 2 500 pcs/reel		
PS2805C-4-V-F4	PS2805C-4-V-F4-A				

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2805C-1	PS2805C-4	
Diode	Forward Current (DC)	lF	±30		mA/ch
	Power Dissipation Derating	⊿P _D /°C	0.6	0.8	mW/°C
	Power Dissipation	Po	60	80	mW/ch
	Peak Forward Current*1	IFP	±0.5		A/ch
Transistor	Collector to Emitter Voltage	Vceo	80		V
	Emitter to Collector Voltage	Veco	Ę	5	V
	Collector Current	lc	3	0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1.	.2	mW/°C
	Power Dissipation	Pc	12	20	mW/ch
Isolation Voltage *2		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100		°C
Storage Temperature		Tstg	-55 to +150		°C

^{*1} PW = 100 μ s, Duty Cycle = 1%

^{*2} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together (PS2805C-1).

Pins 1-8 shorted together, 9-16 shorted together (PS2805C-4).

ELECTRICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	$I_F = \pm 5 \text{ mA}$		1.2	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		20		pF
Transistor	Collector to Emitter Dark Current	ICEO	VcE = 80 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/IF)*1	CTR	IF = ± 5 mA, VcE = 5 V	50		400	%
	Collector Saturation Voltage	V _{CE(sat)}	$I_F = \pm 10 \text{ mA}, I_C = 2 \text{ mA}$		0.13	0.3	V
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *2	Tr	$Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		5		μS
	Fall Time *2	t f			7		

*1 CTR rank

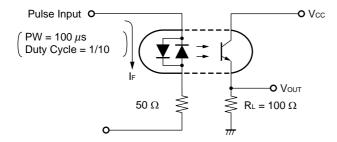
PS2805C-1

N: 50 to 400 (%) M: 100 to 400 (%)

PS2805C-4

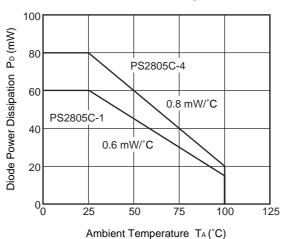
N: 50 to 400 (%) M: 100 to 400 (%)

*2 Test circuit for switching time

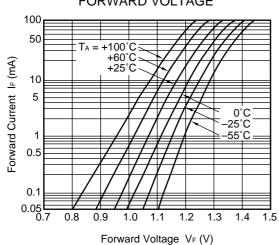


TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

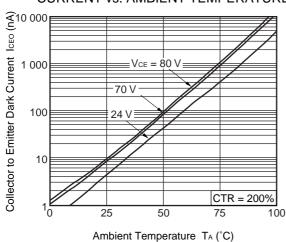




FORWARD CURRENT vs. FORWARD VOLTAGE

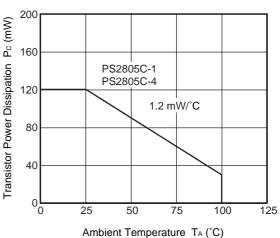


COLLECTOR TO EMITTER DARK **CURRENT vs. AMBIENT TEMPERATURE**

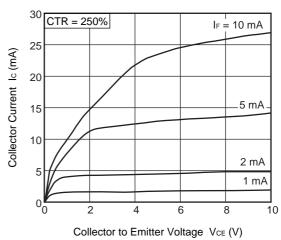


Remark The graphs indicate nominal characteristics.

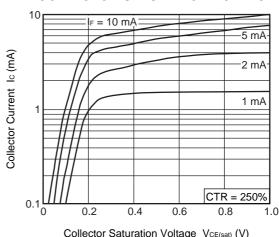
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. **COLLECTOR TO EMITTER VOLTAGE**

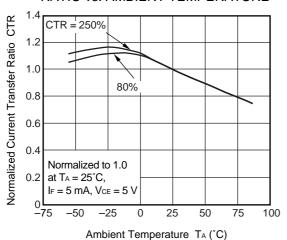


COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**

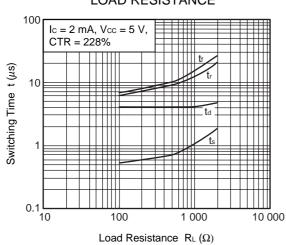


Collector Saturation Voltage VCE(sat) (V)

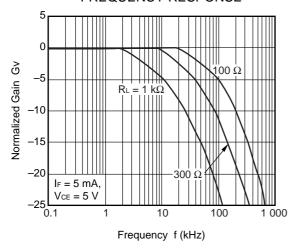
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

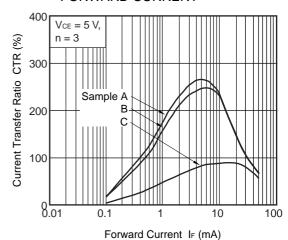


FREQUENCY RESPONSE

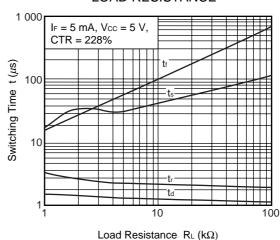


Remark The graphs indicate nominal characteristics.

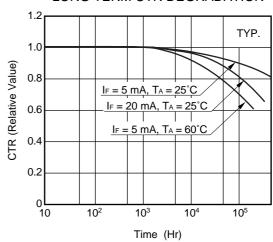
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



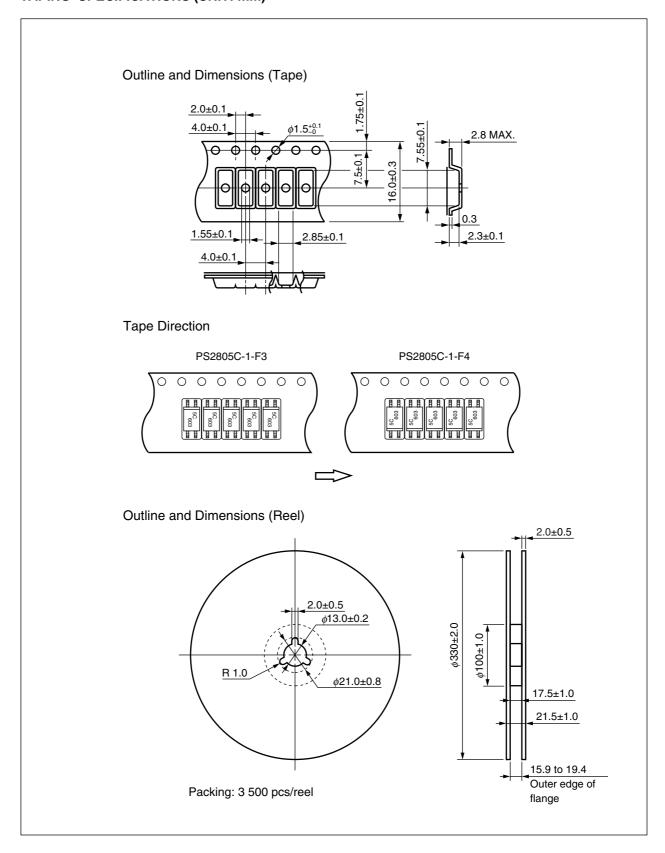
SWITCHING TIME vs. LOAD RESISTANCE

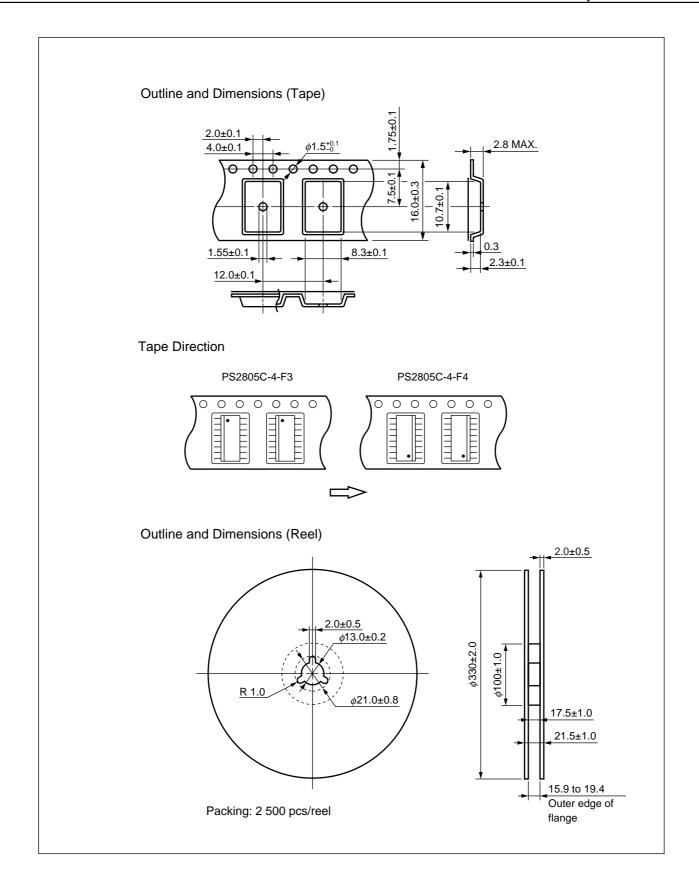


LONG TERM CTR DEGRADATION



TAPING SPECIFICATIONS (UNIT: mm)





NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

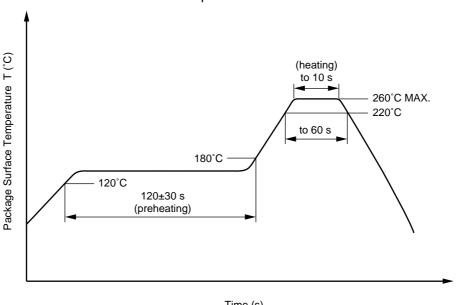
• Time of peak reflow temperature 10 seconds or less 60 seconds or less • Time of temperature higher than 220°C

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below I_F = 1 mA.

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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- The information in this document is current as of June, 2006. The information is subject to change
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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration in CEL	on contained devices	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

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